# 2SD2592L, 2SD2592S

Silicon NPN Triple Diffused Low Frequency Amplifier

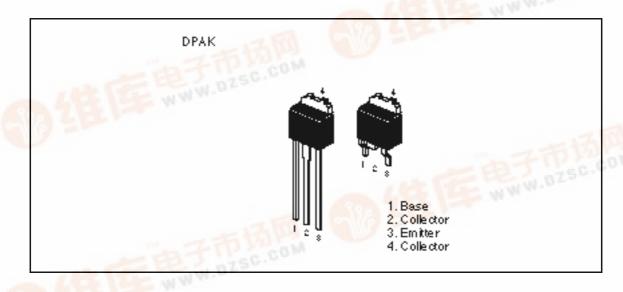
# HITACHI

1st. Edition December 1997 Target Specification

#### **Features**

• High voltage :  $V_{(BR)CEO} = 300V$  min.

#### **Outline**





## 2SD2592L, 2SD2592S

### **Absolute Maximum Ratings** ( $Ta = 25^{\circ}C$ )

Item	Symbol	Ratings	<b>Unit</b>	
Collector to Base voltage	V <sub>CBO</sub>	300		
Collector to Emitter voltage	V <sub>CEO</sub>	300	V	
Emitter to Base voltage	$V_{EBO}$	5	V	
Collector current	I <sub>c</sub>	0.15	Α	
Collector peak current	I <sub>C(peak)</sub>	0.6	Α	
Collector power dissipation	Pc Note1	10	W	
Junction temperature	Tj	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

Note: 1. Value at Tc = 25°C

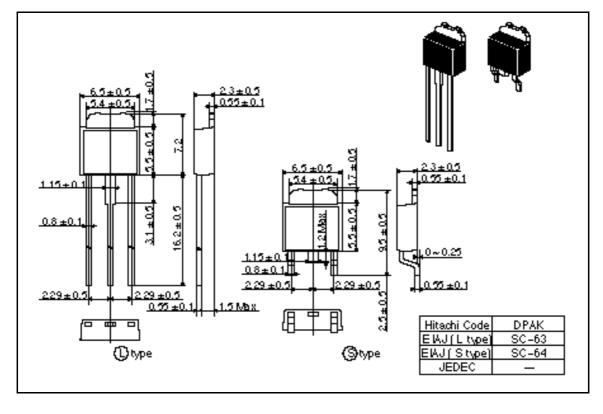
#### **Electrical Characteristics** ( $Ta = 25^{\circ}C$ )

Item	Symbol	Min	Тур	Max	Unit	<b>Test Conditions</b>
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	300	_	_	V	$I_{\rm C}$ = 1mA, $R_{\rm BE}$ =
Emitter to base breakdown voltage	$V_{(BR)EBO}$	5	_	_	V	$I_{E} = 10 \text{mA}, I_{C} = 0$
Collector cutoff current	I <sub>CBO</sub>	_	_	10	μΑ	$V_{CB} = 300V, I_{E} = 0$
Emitter cutoff current	I <sub>EBO</sub>	_	_	10	μΑ	$V_{EB} = 4V, I_C = 0$
DC current transfer ratio	h <sub>FE1</sub>	60	_	200		$V_{CE} = 1.5V, I_{C} = 20mA$
DC current transfer ratio	h <sub>FE2</sub>	60	_	_		$V_{CE} = 5V, I_{C} = 100mA$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	_	1.0		$I_{\rm C}$ = 100mA, $I_{\rm B}$ = 5mA
Base to emitter saturation voltage	$V_{BE(sat)}$	_		1.5		$I_{\rm C}$ = 100mA, $I_{\rm B}$ = 5mA
Gain bandwidth product	f <sub>T</sub>	_	16	_	MHz	$V_{CE} = 1.5A, I_{C} = 20mA$

## 2SD2592L, 2SD2592S

#### **Package Dimensions**

Unit: mm



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#### Hitachi Itd

Semiconductor & IC DW. Nappon Bilda, 2:5-2, Ohtermachi, Chiyoda-ku, Tokyo 100, Japan Tet Tokyo (03, 3270-21111 Fax: 7:03, 3270-2109

For Jurther in forms I on write to:

Hitechi America, Utd. Semiconductor & IC Div. 2000 Sierre Foint Perkwey Briebene, CA. 94005-4835 USA Tet 445-589-8800 Fex: 445-588-4207 Hitachi Burope GmbH
Bectronic Componente Group
Continental Burope
Domechar Strafe 3
D-85832 Feldkirchen
München
Tet (28349 94 80 0
Fex: 08949 29 30 00

Hitschi Burope Ltd.
Bedronic Components Div.
Northern Burope Hesidquerters
Whitebrook Ferk
Lower Cookhem Road
Maiderheed
Bestschire SL68YA
United Kingdom
Tet 0628-885000
Fex: 0628-778322

Hitechi Asia Pte. Ltd 45 Collyer Gusy \$20-00 Hitechi Tower Singapore 0104 Tet 535-2100 Fex: 535-1533

Hitechi Asia (Hong Kong) Ltd. Unit 705, North Towar, World Finance Centra, Herbour City, Centon Road Teim Sha Teul, Kowloon Hong Kong Tet 27359218 Fex: 27309074

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